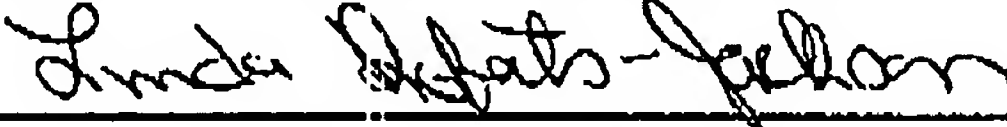


10/605,369

FIS920030011US1

I hereby certify that this paper and fee are being TRANSMITTED VIA FACSIMILE TO: Assistant Commissioner for Patents, P. O. Box 1450, ALEXANDRIA, VA 22313-1450. Date of Deposit: 06/09/05 Name of Person Making Deposit: Linda Roberts-Jackson

Signature



In the United States Patent and Trademark Office

Date: 6/09/05**In re** Lloyd Burrell, et al.**Filed:** 9/25/03**Applicat
ion of:****For:** SEMICONDUCTOR DEVICE HAVING A COMPOSITE
LAYER IN ADDITION TO A BARRIER LAYER BETWEEN
COPPER WIRING AND ALUMINUM BOND PAD**Serial
Number** 10/605,369**Confirmation No.**
2368**:****Art** 2814**Examiner:** MAI, ANH D.**Unit:**

AM 6/9/05

AMENDMENT AFTER FINAL REJECTION

Hon. Commissioner of Patents and Trademarks
P. O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Please enter
AM 6/9/05

In response to the Office Action mailed April 4, 2005, the present application is
amended as follows: